

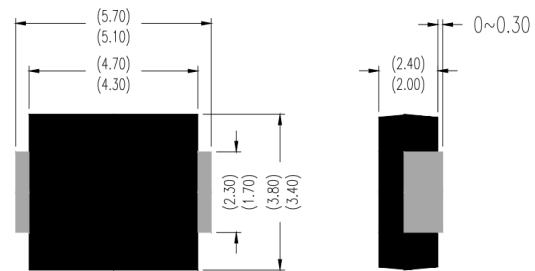


## Surface Mount Schottky Rectifier

### Features

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

DO-214AA (SMB)

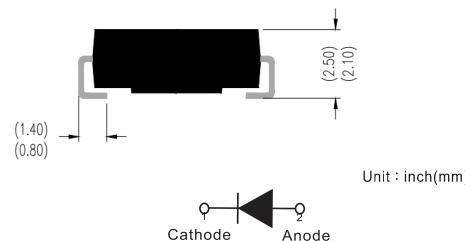


### Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### Mechanical Data

- **Package:** DO-214AA (SMB)  
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end



Unit : inch(mm)

### ■Maximum Ratings ( $T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS32	SS33	SS34	SS35	SS36	SS38	SS310	SS315	SS320
Repetitive peak reverse voltage	$V_{RRM}$	V	20	30	40	50	60	80	100	150	200
Average rectified output current @60Hz sine wave, resistance load, $T_c$ (FIG.1)	$I_o$	A						3.0			
Surge(non-repetitive)forward current @60Hz half-sine wave, 1 cycle, $T_a=25^\circ\text{C}$	$I_{FSM}$	A					70				
Storage temperature	$T_{stg}$	$^\circ\text{C}$					-55 ~+150				
Junction temperature	$T_j$	$^\circ\text{C}$				-55 ~+150			-55 ~+175		

### ■Electrical Characteristics ( $T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	SS32	SS33	SS34	SS35	SS36	SS38	SS310	SS315	SS320
Maximum instantaneous forward voltage drop per diode	$V_F$	V	$I_{FM} = 3.0\text{A}$	0.55			0.70		0.85		0.95	
Maximum DC reverse current at rated DC blocking voltage per diode @ $V_{RM}=V_{RRM}$	$I_{RRM}$	mA	$T_a=25^\circ\text{C}$		0.50				0.10			
			$T_a=100^\circ\text{C}$		10				5			

### ■Thermal Characteristics ( $T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS32	SS33	SS34	SS35	SS36	SS38	SS310	SS315	SS320
Thermal resistance	$R_{\theta J-A}$	$^\circ\text{C/W}$				55 <sup>1)</sup>					
	$R_{\theta J-C}$						20 <sup>1)</sup>				

Note:

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16mm) copper pad areas



## ■ Characteristics(Typical)

